- Sensitive Gate Triacs
- 4 A RMS
- Glass Passivated Wafer
- 400 V to 700 V Off-State Voltage
- Max I_{GT} of 5 mA (Quadrants 1 3)

Pin 2 is in electrical contact with the mounting base.

MDC2ACA

absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING			VALUE	UNIT
	TIC206D		400	
Repetitive peak off-state voltage (see Note 1)	TIC206M	V_{DRM}	600	V
	TIC206S		700	
Full-cycle RMS on-state current at (or below) 85°C case temperature (see Note 2)			4	Α
Peak on-state surge current full-sine-wave at (or below) 25°C case temperature (see Note 3)			25	Α
Peak gate current			±0.2	Α
Peak gate power dissipation at (or below) 85°C case temperature (pulse width ≤ 200 μs)			1.3	W
Average gate power dissipation at (or below) 85°C case temperature (see Note 4)			0.3	W
Operating case temperature range			-40 to +110	°C
Storage temperature range			-40 to +125	°C
Lead temperature 1.6 mm from case for 10 seconds			230	°C

- NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.
 - 2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 85°C derate linearly to 110°C case temperature at the rate of 160 mA/°C.
 - 3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.
 - 4. This value applies for a maximum averaging time of 20 ms.

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER			TEST CONDITIONS MIN			TYP	MAX	UNIT
I _{DRM}	Repetitive peak off-state current	V _D = rated V _{DRM}	I _G = 0	T _C = 110°C			±1	mA
I _{GT}		V _{supply} = +12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		0.9	5	
	Gate trigger	$V_{\text{supply}} = +12 \text{ V}\dagger$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$		-2.2	-5	mA
	current	$V_{\text{supply}} = -12 \text{ V}\dagger$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$		-1.8	-5	ША
		$V_{\text{supply}} = -12 \text{ V}^{\dagger}$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$		2.4	10	
V _{GT}		V _{supply} = +12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		0.7	2	
	Gate trigger	$V_{\text{supply}} = +12 \text{ V}\dagger$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$		-0.7	-2	v
	voltage	$V_{\text{supply}} = -12 \text{ V}^{\dagger}$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$		-0.7	-2	V
		$V_{\text{supply}} = -12 \text{ V}^{\dagger}$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$		0.7	2	

[†] All voltages are with respect to Main Terminal 1.



TIC206 SERIES SILICON TRIACS

DECEMBER 1971 - REVISED FEBRUARY 2001

electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)

PARAMETER TEST CONDITIONS			MIN	TYP	MAX	UNIT		
V _T	On-state voltage	I _T = ±4.2 A	I _G = 50 mA	(see Note 5)		±1.4	±2.2	V
I _H	Holding current	V _{supply} = +12 V†	I _G = 0	Init' I _{TM} = 100 mA		1.5	15	mA
		V _{supply} = -12 V†	$I_G = 0$	Init' $I_{TM} = -100 \text{ mA}$		-1.3	-15	
IL	Latching current	V _{supply} = +12 V†	(see Note 6)			30	mA	
		$V_{\text{supply}} = -12 \text{ V}\dagger$					-30	1117 (
dv/dt	Critical rate of rise of	V _{DRM} = Rated V _{DRM}	I _G = 0	T _C = 110°C		±20		V/µs
	off-state voltage					120		ν/μ5
dv/dt _(c)	Critical rise of	V _{DRM} = Rated V _{DRM}	$I_{TRM} = \pm 4.2 A$	T - 95°C	±1	±3		V/µs
	commutation voltage			$T_C = 85^{\circ}C$		±3		v/μS

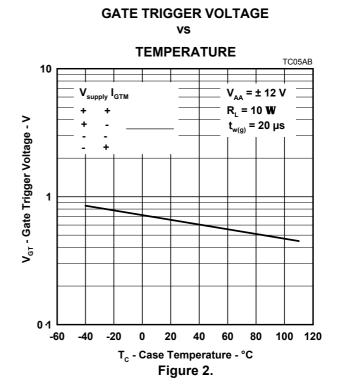
[†] All voltages are with respect to Main Terminal 1.

thermal characteristics

PARAMETER			TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			7.8	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

TYPICAL CHARACTERISTICS

GATE TRIGGER CURRENT VS **TEMPERATURE** 100 $V_{\Delta\Delta} = \pm 12 \text{ V}$ R_L = 10 W $t_{w(g)}$ = 20 μs l_{στ} - Gate Trigger Current - mA 10 01 100 120 -60 -40 -20 0 20 40 60 80 T_c - Case Temperature - °C Figure 1.

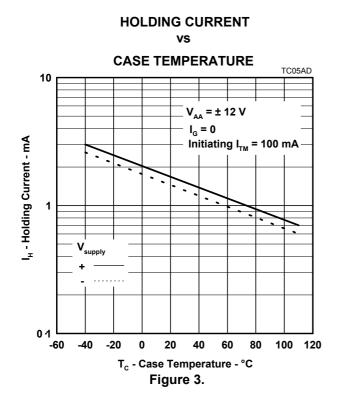


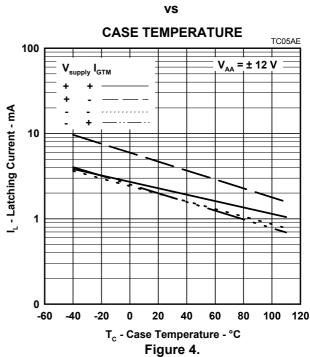
PRODUCT INFORMATION

NOTES: 5. This parameter must be measured using pulse techniques, $t_p = \le 1$ ms, duty cycle ≤ 2 %. Voltage-sensing contacts separate from the current carrying contacts are located within 3.2 mm from the device body.

^{6.} The triacs are triggered by a 15-V (open circuit amplitude) pulse supplied by a generator with the following characteristics: $R_G = 100 \ \Omega$, $t_{p(g)} = 20 \ \mu s$, $t_r = \le 15 \ ns$, $f = 1 \ kHz$.

TYPICAL CHARACTERISTICS





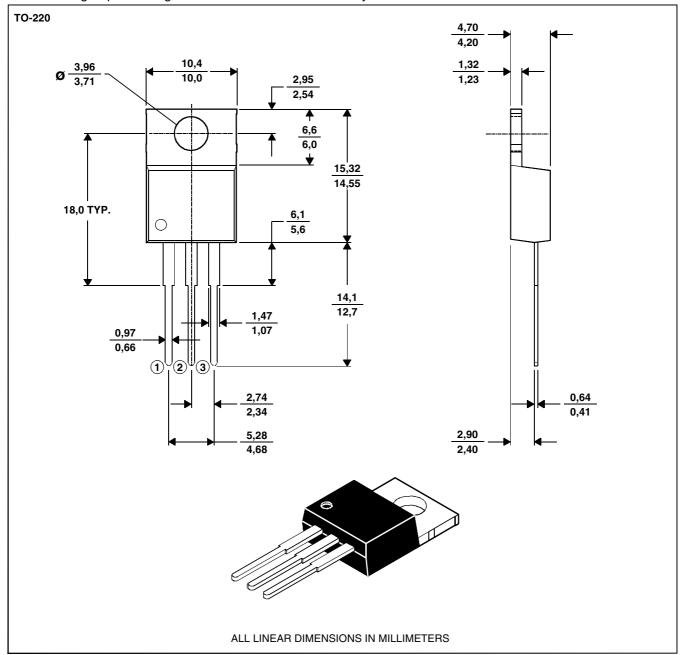
LATCHING CURRENT

MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTE A: The centre pin is in electrical contact with the mounting tab.

PRODUCT INFORMATION

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